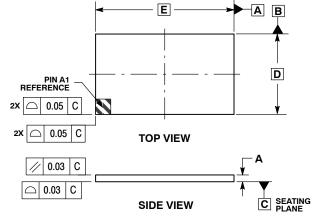
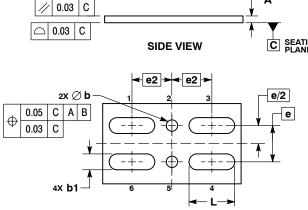




WLCSP6, 1.77x3.05 CASE 567KS ISSUE O

DATE 29 OCT 2014





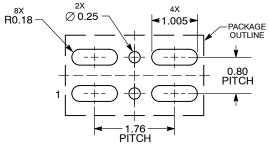
BOTTOM VIEW

NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS.

	MILLIMETERS		
DIM	MIN	MAX	
Α		0.145	
b	0.22	0.28	
b1	0.32	0.38	
D	1.77 BSC		
E	3.05 BSC		
е	0.80 BSC		
e2	0.8775 BSC		
L	0.975	1.035	

RECOMMENDED **SOLDERING FOOTPRINT***



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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